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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Minakshisundaran B. Anand et

al.

Application No.: 10/690,238

Filed: 10/21/2003

Title: COMPUTER AIDED DESIGN
METHOD AND APPARATUS FOR
MODELING AND ANALYZING ON-CHIP
INTERCONNECT STRUCTURES

Attorney Docket No.: YOR920030315US1

Group Art Unit:

2825

Examiner:

Unknown

REQUEST FOR CORRECTION

Office of Initial Patent Examination's Customer Service Center Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

Petitioner hereby requests a correction in the Filing Receipt of the above-referenced patent application. In particular, the application is associated with Customer No. 33233. Enclosed is a copy of the Filing Receipt with the changes noted thereon.

Respectfully submitted,

Date

Charles W. Peterson, Jr.

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Attorney for Applicant

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Page 1 of 2



United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Tradestark Office Address COMMISSIONER FOR PATENTS P.O. Dox 1430 Alexandra, Vagrica 22313-1450

APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY.DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS	
10/690 238	10/21/2003	2825	914	YOR920030315US1	13	28	3	

2223 Law Officet of Charles W. Peterson, Jr. P.O. Box 710627 Oak Hill. VA 20171 **CONFIRMATION NO. 4930**

FILING RECEIPT
OC00000011727784

Date Mailed: 01/21/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filling Receipt, please write to the Office of Initial Patent Examination's Filling Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filling Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filling Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filling Receipt incorporating the requested corrections (if appropriate).

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Foreign Applications

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Early Publication Request: No

Tittle

Computer aided design method and apparatus for modeling and analyzing on-chip interconnect